

Call for Papers
ISCIE/ASME 2014 International Symposium on Flexible Automation (ISFA2014)
14 - 16 July 2014
Awaji-Island, Hyogo, Japan
<http://www-dsc.mech.eng.osaka-u.ac.jp/ISFA2014/>

Virtual and Augmented Reality

The objective of this session is to provide a forum for discussions of the research and development on Virtual Reality and Augmented Reality techniques in engineering design, manufacturing, analysis, and simulation. The topics of interest for this session include, but are not limited to, the following topics:

- Virtual, Augmented & Mixed Reality Systems
- Virtual Manufacturing
- CAD & Computer Graphics
- Haptic Interaction
- Virtual Humans
- Distributed and Collaborative Virtual Environments
- Scientific Visualization
- VR/AR Applications

Original papers on the aforementioned topics of interest are encouraged for submission to the session. Papers from the industrial sector are encouraged.

Paper Submission

All papers should be written in English. Both long and short papers will be considered. A long paper is defined as from 6 to 8 proceedings pages and a short paper as less than 4 pages (about 1000 words per page). Long papers are reviewed as full manuscripts including abstract (about 150 words) and keywords. Short papers are screened by a 600-1000 word summary with keywords. The manuscripts and summaries should include: title of the paper, name(s) and affiliation(s) of author(s); mailing address and e-mail address of the contact person. The templates for manuscript and summary are posted on the conference web site. Please submit your manuscript(s) per the instructions posted on the conference website (<http://www-dsc.mech.eng.osaka-u.ac.jp/ISFA2014/>).

Submission Deadlines

Paper submission: **November 29, 2013**
Paper acceptance notification: **March 1, 2014**
Submission of final Paper: **April 4, 2014**

Session Co-Organizer(s)

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